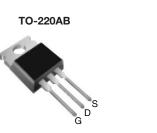


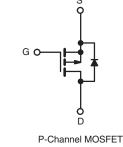
**Vishay Siliconix** 



## Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.50			
Q <sub>g</sub> (Max.) (nC)	12				
Q <sub>gs</sub> (nC)	3.8				
Q <sub>gd</sub> (nC)	5.1				
Configuration	Single				





### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lood (Db) free	IRF9Z14PbF
Lead (Pb)-free	SiHF9Z14-E3
SnPb	IRF9Z14
	SiHF9Z14

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	- 60	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current	$V_{GS} \text{ at } -10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		- 6.7	А	
	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	- 4.7		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	- 27	1		
Linear Derating Factor		0.29	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	140	mJ		
Repetitive Avalanche Current <sup>a</sup>	I <sub>AR</sub>	- 6.7	Α		
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	4.3	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	PD	43	W	
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	**	
Soldering Recommendations (Peak Temperature)	for 10 s	-	300 <sup>d</sup>	°C	
Mounting Torque	6.00 or M0 corous		10	lbf · in	
	6-32 or M3 screw		1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = - 25 V, starting T<sub>J</sub> = 25 °C, L = 3.6 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = - 6.7 A (see fig. 12).

c.  $I_{SD} \leq$  - 6.7 A, dI/dt  $\leq$  90 A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq$  175 °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 -			°C/W			
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>							
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 3.5						
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	•	•						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = - 1	250 µA	- 60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I	I <sub>D</sub> = - 1 mA	-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		- 2.0	-	- 4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	- 100	μA		
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = - 48 V, $V_{GS}$ = 0 V, $T_{J}$ = 150 °C		-	-		- 500	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub>	= - 4.0 A <sup>b</sup>	-	-	0.50	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 2	25 V, I <sub>D</sub> =	- 4.0 A <sup>b</sup>	1.4	-	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V}, \\ V_{DS} = -25 \text{ V}, \\ f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	270	-	pF	
Output Capacitance	C <sub>oss</sub>			-	170	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	31	-		
Total Gate Charge	Qg				-	-	12	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		= - 6.7 A, V <sub>DS</sub> = - 48 V, see fig. 6 and 13 <sup>b</sup>	-	-	3.8	nC
Gate-Drain Charge	Q <sub>gd</sub>		0001	ig. o and to	-	-	5.1	
Turn-On Delay Time	t <sub>d(on)</sub>				-	11	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 30 V, $I_D$ = - 6.7 A, R <sub>g</sub> = 24 $\Omega$ , R <sub>D</sub> = 4.0 $\Omega$ , see fig. 10 <sup>b</sup>		-	63	-	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	10	-		
Fall Time	t <sub>f</sub>			-	31	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-		
Drain-Source Body Diode Characteristi	cs	•						
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 6.7	A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 27		
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = -6.7 \text{ A}, V_{GS} = 0 \text{ V}^{b}$			-	-	- 5.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = -6.7 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^b$		-	80	160	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.096	0.19	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn		on in day	minatod b	vil and	1 )	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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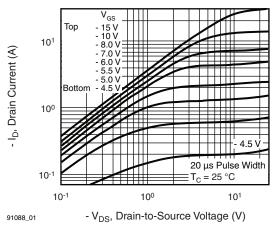
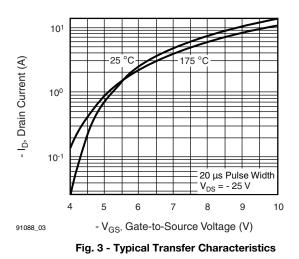


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C



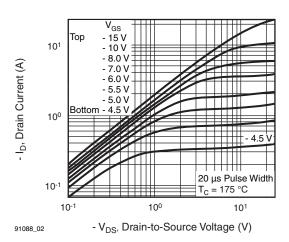


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175  $^\circ$  C

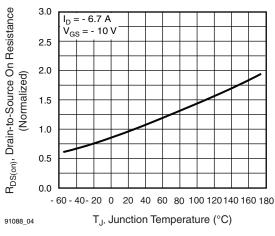


Fig. 4 - Normalized On-Resistance vs. Temperature

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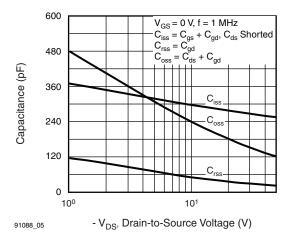


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

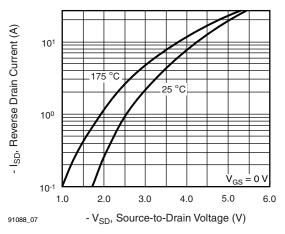


Fig. 7 - Typical Source-Drain Diode Forward Voltage

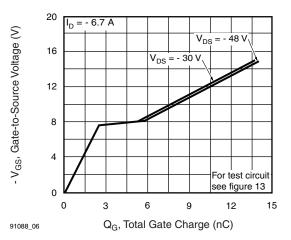


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

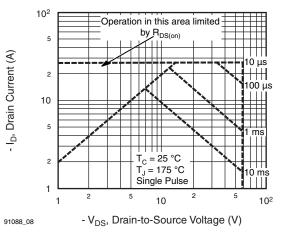


Fig. 8 - Maximum Safe Operating Area



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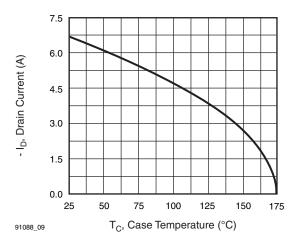


Fig. 9 - Maximum Drain Current vs. Case Temperature

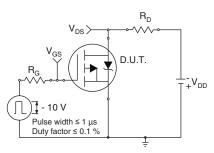


Fig. 10a - Switching Time Test Circuit

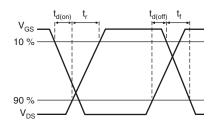


Fig. 10b - Switching Time Waveforms

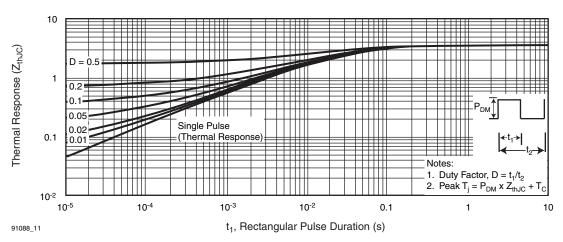


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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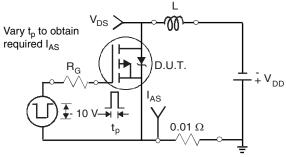


Fig. 12a - Unclamped Inductive Test Circuit

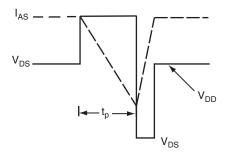


Fig. 12b - Unclamped Inductive Waveforms

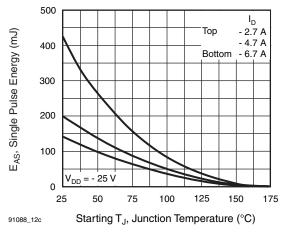


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

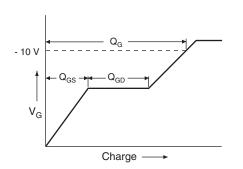


Fig. 13a - Basic Gate Charge Waveform

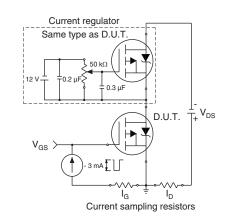
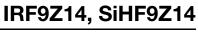


Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

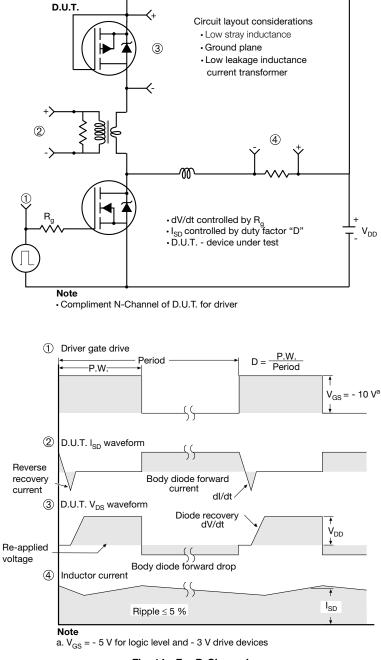


Fig. 14 - For P-Channel

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